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AKY
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Case No. 10269/3

In re Application of:

CONVEYANCE SYSTEM

Serial No: 09/490,507

Examiner: Steven A. Bartlie

Filed: January 25, 2000

Group Art Unit: 3652

For: Takumi MIZOKAWA, Makoto
MORI, Yuzo TAKAKADO, Hitoshi
KAWANO

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

RECEIVED
JUN 14 2002
GROUP 3600

Dear Sir:

Before the examination of the present application, please enter the following amendment and consider the following remarks:

IN THE CLAIMS:

(1) Please replace claim 1 with the following new claim 1 (APPENDIX 1):

Sub 017
1. (twice amended) A wafer conveyance system, comprising:
a chamber having a plurality of outgoing ducts from its circumference, each
connecting to an insertion portion of each one of a plurality of wafer processing apparatuses;
a guide path provided in said chamber;
a mobile element movable along said guide path, and capable of receiving one or
more processed wafers, via said duct, from said insertion portion of one of said wafer